

## Series PVD33N

Microelectronic Power IC  
HEXFET® Power MOSFET Photovoltaic Relay  
Single-Pole, Normally-Open  
0-300V DC, 240mA

### General Description

The PVD33 Series DC Relay (PVD) is a single-pole, normally open, solid-state replacement for electromechanical relays used for general purpose switching of analog signals. It utilizes International Rectifier's HEXFET power MOSFET as the output switch, driven by an integrated circuit photovoltaic generator of novel construction. The output switch is controlled by radiation from a GaAlAs light emitting diode (LED), which is optically isolated from the photovoltaic generator.

The PVD33 Series overcomes the limitations of both conventional electromechanical and reed relays by offering the solid state advantages of long life, fast operating speed, low pick up power, bounce-free operation, low thermal offset voltages and miniature package. These advantages allow product improvement and design innovations in many applications such as process control, multiplexing, automatic test equipment and data acquisition.

The PVD33 can switch analog signals from thermocouple level to 300 Volts peak DC. Signal frequencies into the RF range are easily controlled and switching rates up to 500Hz are achievable. The extremely small thermally generated offset voltages allow increased measurement accuracies.

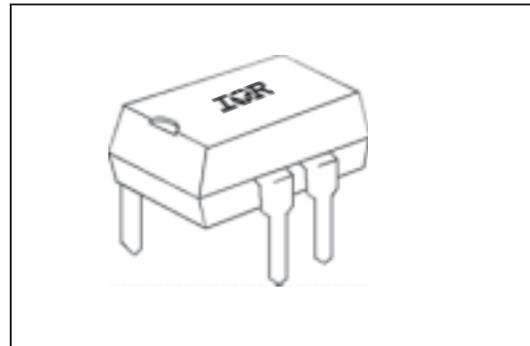
These relays are packaged in 8-pin, molded DIP packages and available with either through-hole or surface-mount ("gull-wing") leads, in plastic shipping tubes.

### Applications

- Process Control
- Data Acquisition
- Test Equipment
- Multiplexing and Scanning

### Features

- Bounce-Free Operation
- $10^{10}$  Off-State Resistance
- 1,000 V/ $\mu$ sec dv/dt
- 5 mA Input Sensitivity
- 4,000 V<sub>RMS</sub> I/O Isolation
- Solid-State Reliability
- UL Recognition pending
- ESD Tolerance:
  - 4000V Human Body Model
  - 500V Machine Model



### Part Identification

PVD2352N	
PVD3354N	through-hole
PVD2352NS	surface-mount
PVD3354NS	(gull-wing)

*(HEXFET is the registered trademark for International Rectifier Power MOSFETs)*

**Electrical Specifications** ( $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$  unless otherwise specified)

INPUT CHARACTERISTICS	PVD2352N	PVD3354N	Units
Minimum Control Current (see figures 1 and 2) For 250mA Continuous Load Current For 240mA Continuous Load Current For 200mA Continuous Load Current	2 5 5		DC mA@25°C mA@40°C mA@85°C
Maximum Control Current for Off-State Resistance at 25°C	10		μA(DC)
Control Current Range (Caution: current limit input LED. See figure 6)	2.0 to 25		mA(DC)
Maximum Reverse Voltage	7.0		V(DC)

OUTPUT CHARACTERISTICS	PVD2352N	PVD3354N	Units
Operating Voltage Range	200	300	V <sub>(peak)</sub>
Maximum Load Current 40°C I LED 5mA	240		mA(DC)
Response Time @25°C (see figures 7 and 8) Max. T <sub>(on)</sub> @ 12mA Control, 50 mA Load, 100 VDC Max. T <sub>(off)</sub> @ 12mA Control, 50 mA Load, 100 VDC	100 110		μs
Max. On-state Resistance 25°C (Pulsed) (fig. 4) 50 mA Load, 5mA Control	6		Ω
Min. Off-state Resistance 25°C (see figure 5)	10 <sup>8</sup> @ 160VDC	10 <sup>10</sup> @ 240VDC	Ω
Max. Thermal Offset Voltage @ 5.0mA Control	0.2		μvolts
Min. Off-State dv/dt	1000		V/μs
Typical Output Capacitance (see figure 9)	10		pF @ 50VDC

GENERAL CHARACTERISTICS	(PVD2352N and PVD3354N)	Units
Dielectric Strength: Input-Output	4000	V <sub>RMS</sub>
Insulation Resistance: Input-Output @ 90V <sub>DC</sub>	10 <sup>12</sup> @ 25°C - 50% RH	Ω
Maximum Capacitance: Input-Output	1.0	pF
Max. Pin Soldering Temperature (1.6mm below seating plane, 10 seconds max.)	+260	°C
Ambient Temperature Range: Operating	-40 to +85	
Storage	-40 to +100	

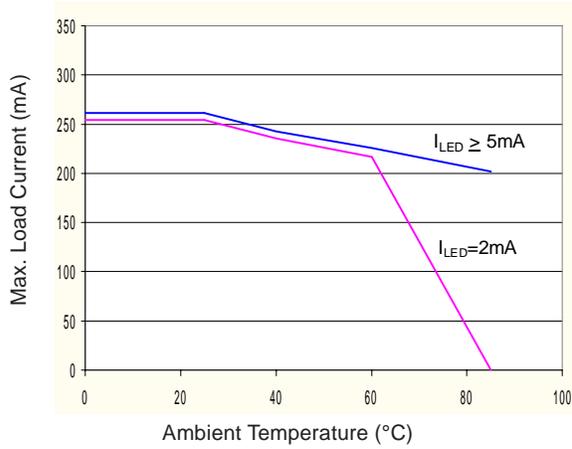


Figure 1. Current Derating Curves

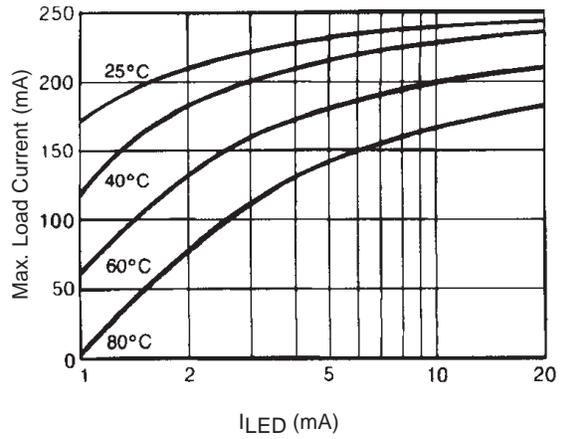


Figure 2. Typical Control Current Requirements

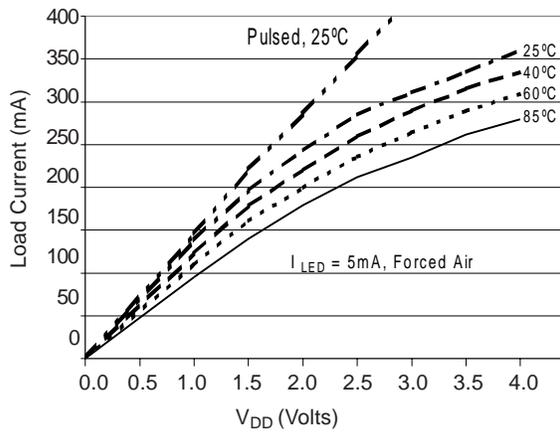


Figure 3. Typical On Characteristics

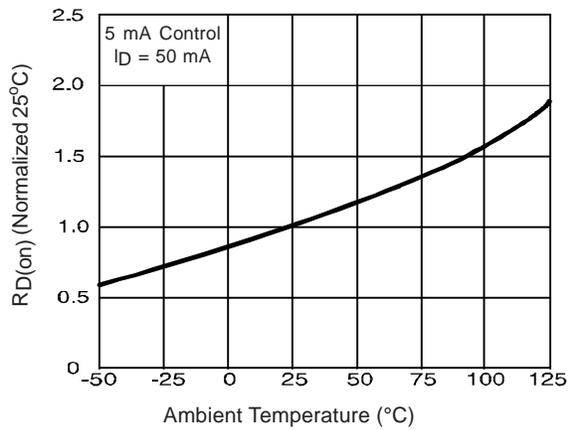


Figure 4. Typical On-Resistance

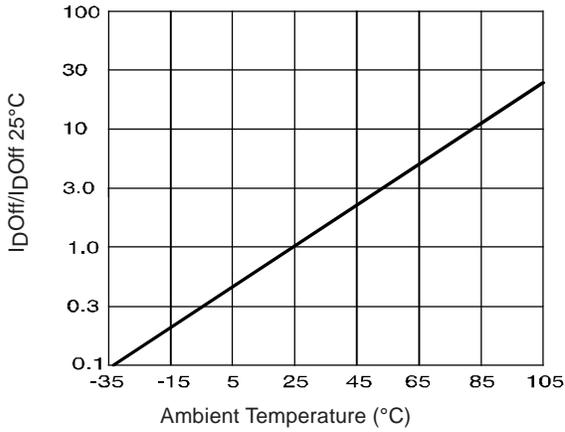


Figure 5. Normalized Off-State Leakage

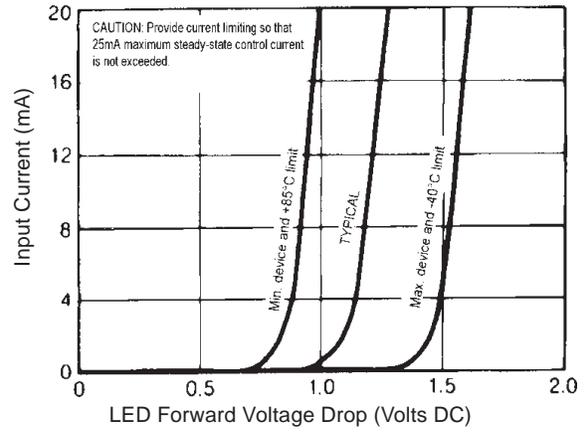


Figure 6. Input Characteristics  
(Current Controlled)

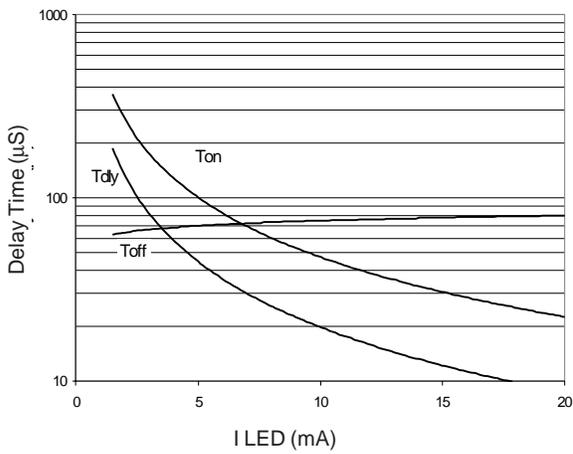


Figure 7. Typical Delay Times

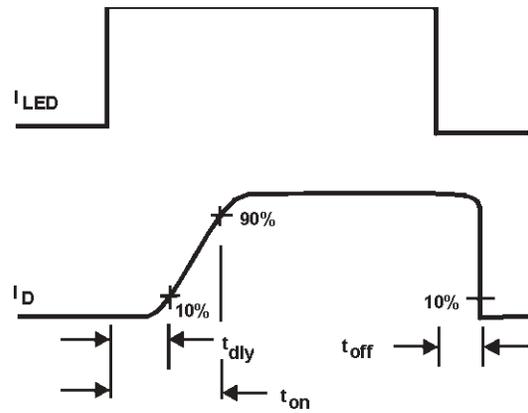


Figure 8. Delay Time Definitions

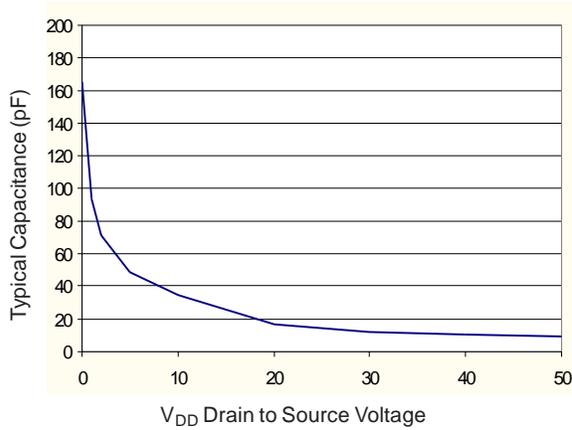
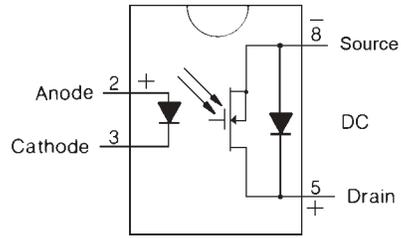
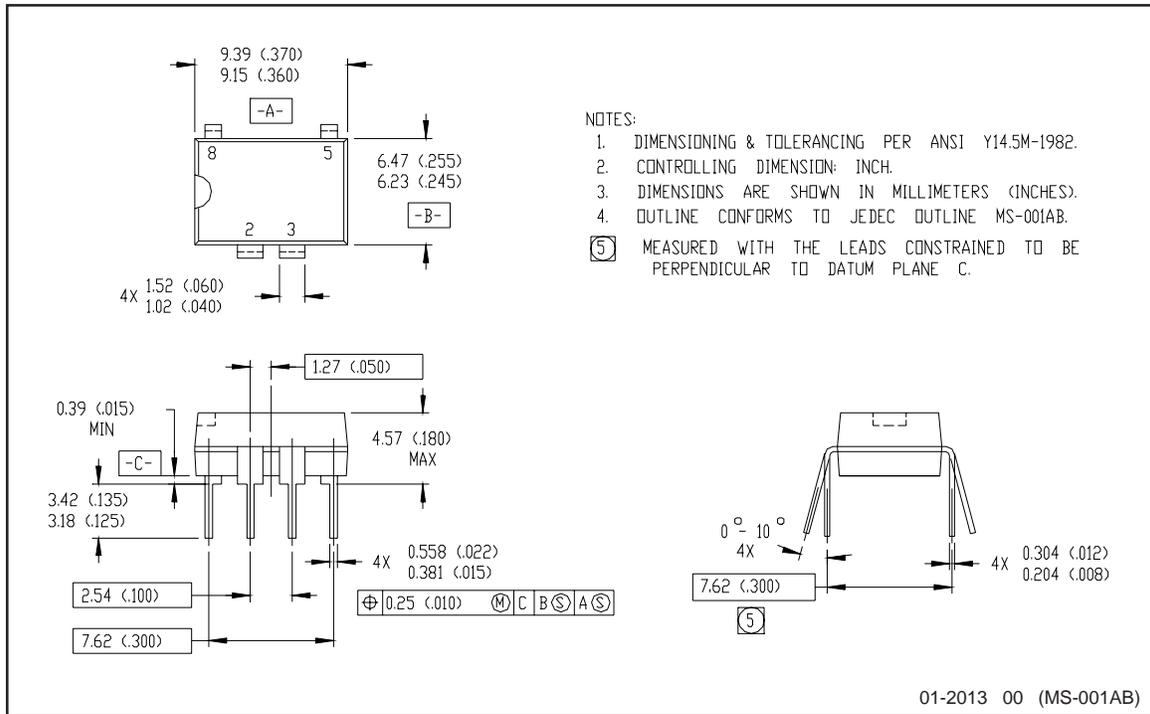


Figure 9. Typical Output Capacitance

Wiring Diagram



Case Outline



Case Outline

